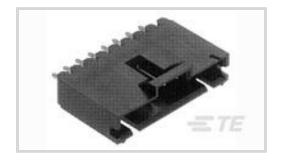
# 103639-4 - ACTIVE

### AMPMODU | AMPMODU MTE

TE Internal #: 103639-4 PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin-Lead, Through Hole - Solder, AMPMODU MTE

View on TE.com >

### Connectors > PCB Connectors > PCB Headers & Receptacles



## Connector System: Wire-to-Board

Number of Positions: 5

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

## Features

## **Product Type Features**

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No



Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	5
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Termination Resistance	15 mΩ
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	600 V
Body Features	
Primary Product Color	Black
Contact Features	
Contact Mating Area Length	5.84 mm[.23 in]
Mating Square Post Dimension	.64 mm[.025 in]

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin-Lead, Through Hole - Solder, AMPMODU MTE



PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin-Lead
Contact Type	Pin
Contact Current Rating (Max)	3 A
ermination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.3 mm[.13 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Latched, Polarization
Mating Retention	With
Panel Mount Feature	Without
Mating Retention Type	Polarized Lock
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
lousing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Length	15.24 mm[.6 in]
Connector Height	13.59 mm[.535 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Jsage Conditions	

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin-Lead, Through Hole - Solder, AMPMODU MTE



Circuit Application	Signal							
ndustry Standards								
Approved Standards	CSA LR7189, UL E28476							
UL Flammability Rating	UL 94V-0							
Packaging Features								
Packaging Quantity	36							
Packaging Type	Box, Tube							
Product Compliance								
•	Not Compliant							
For compliance documentation, visit the product page on TE.com>	Not Compliant Compliant with Exemptions							

### Halogen Content

Solder Process Capability

### Pb (13% in Component Part)

#### Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin-Lead, Through Hole - Solder, AMPMODU MTE



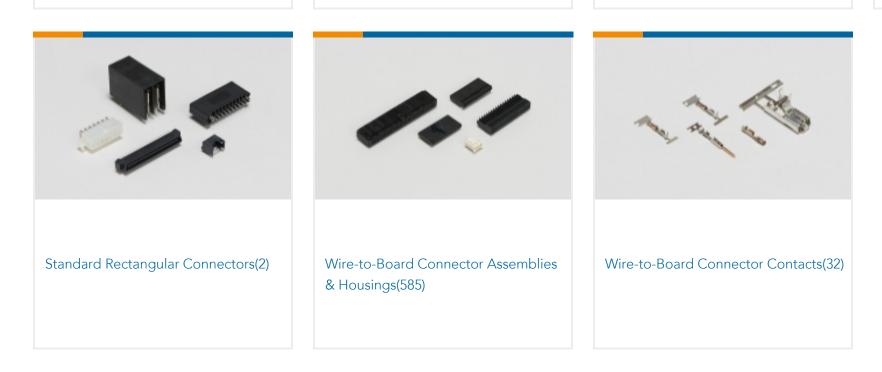




# Also in the Series AMPMODU MTE



		3		u	$\circ$		0		L/	1		u	C	ιL	I C	)				U	$\cup$	' 1	0	1	_	/	
--	--	---	--	---	---------	--	---	--	----	---	--	---	---	----	-----	---	--	--	--	---	--------	-----	---	---	---	---	--



# Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin-Lead, Through Hole - Solder, AMPMODU MTE



## Documents

**Product Drawings** 05 MTE HDR SRST LATCH .100CL

English

## **CAD** Files

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_103639-4\_AA.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_103639-4\_AA.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_103639-4\_AA.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages AMPMODU MTE INTERCONNECT SYSTEM

English

**Product Specifications** Application Specification

English

**Instruction Sheets** Instruction Sheet (U.S.)

English